

MOS FIELD EFFECT TRANSISTOR μ PA1704

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

This μ PA1704 is N-Channel MOS Field Effect Transistor designed for power management applications and Li-ion battery application.

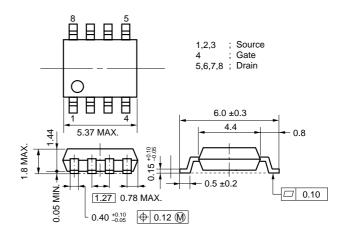
FEATURES

- 2.5-V gate drive and low on-resistance $R_{DS(on)1}=13~m\Omega$ MAX. (Ves = 4.0 V, ID = 5.0 A) $R_{DS(on)2}=16~m\Omega$ MAX. (Ves = 2.5 V, ID = 5.0 A)
- Low Ciss : Ciss = 2700 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1704G	Power SOP8

PACKAGE DRAWING (Unit: mm)



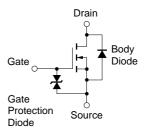
ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

Drain to Source Voltage (VGS = 0 V)	Voss	30	V
Gate to Source Voltage (Vps = 0 V)	Vgss	±12	V
Drain Current (DC)	ID(DC)	±10	Α
Drain Current (pulse) Note1	ID(pulse)	±40	Α
Total Power Dissipation $(T_A = 25^{\circ}C)^{Note2}$	Рт	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to + 150	°C

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1 %

2. Mounted on ceramic substrate of 1200 mm² x 0.7 mm

EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

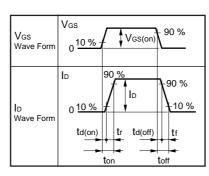


ELECTRICAL CHARACTERISTICS (T_A = 25 °C, All terminals are connected.)

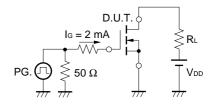
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 4.0 V, Ib = 5.0 A		9.8	13	mΩ
	RDS(on)2	Vgs = 2.5 V, Ip = 5.0 A		12	16	mΩ
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	0.5	0.8	1.5	٧
Forward Transfer Admittance	yfs	Vps = 10 V, Ip = 5.0 A	10	25		S
Drain Leakage Current	Ipss	V _{DS} = 30 V, V _{GS} = 0 V			10	μΑ
Gate to Source Leakage Current	Igss	Vgs = ±12 V, Vps = 0 V			±10	μΑ
Input Capacitance	Ciss	V _{DS} = 10 V		2700		pF
Output Capacitance	Coss	Vgs = 0 V		880		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		400		pF
Turn-on Delay Time	t _{d(on)}	ID = 5.0 A		25		ns
Rise Time	tr	VGS(on) = 4.0 V		95		ns
Turn-off Delay Time	t _{d(off)}	V _{DD} = 15 V		235		ns
Fall Time	tf	$R_G = 10 \Omega$		200		ns
Total Gate Charge	QG	ID = 10 A		38		nC
Gate to Source Charge	Qgs	V _{DD} = 24 V		3.3		nC
Gate to Drain Charge	Q _{GD}	Vgs = 4.0 V		15		nC
Body Diode Forward Voltage	V _{F(S-D)}	IF = 10 A, VGS = 0 V		0.8		V
Reverse Recovery Time	trr	IF = 10 A, VGS = 0 V		48		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μs		53		nC

TEST CIRCUIT 1 SWITCHING TIME

PG. \uparrow R_{Rg} \downarrow V_{GS} 0 $\tau = 1 \, \mu \text{s}$ Duty Cycle $\leq 1 \, \%$

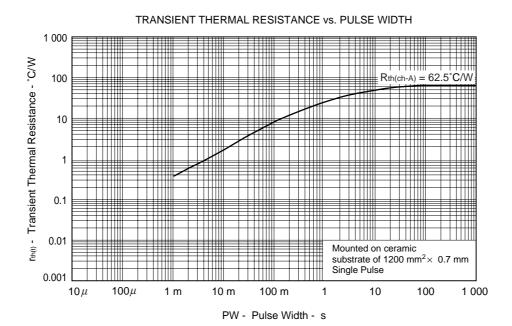


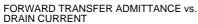
TEST CIRCUIT 2 GATE CHARGE

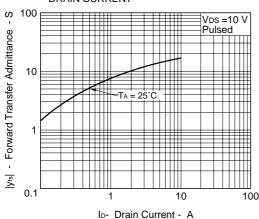




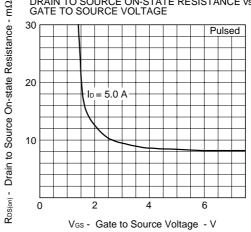
TYPICAL CHARACTERISTICS (TA = 25 °C)



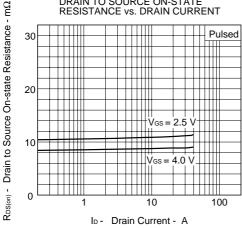




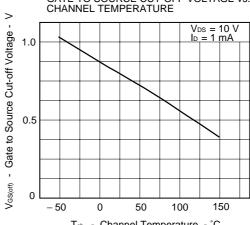
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



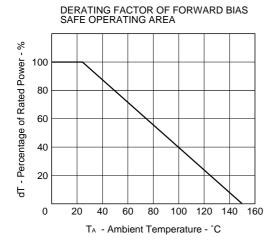
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

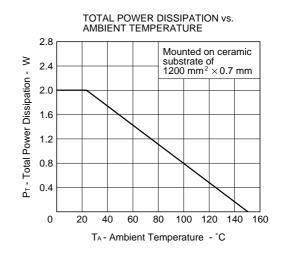


GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

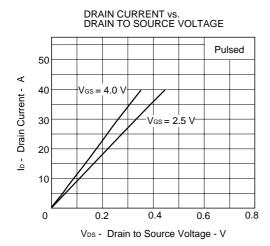


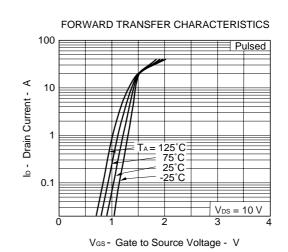
Tch - Channel Temperature - °C

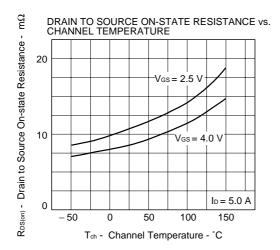


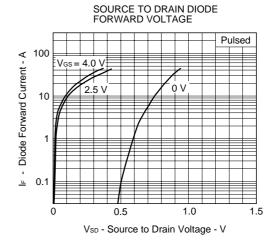


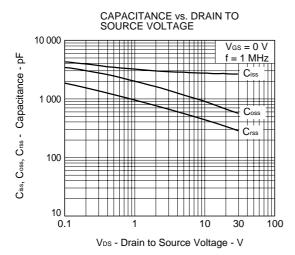
Remark Mounted on ceramic substrate of 1200 mm^2 x 0.7 mm

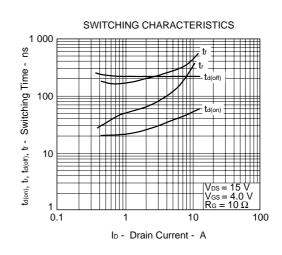


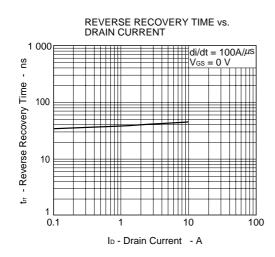


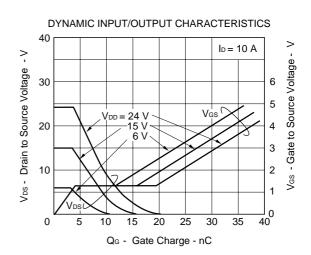












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